

[] SCM

2000. 06

Team

Agenda

Semiconductor

1.

2.

3. System Architecture

4.

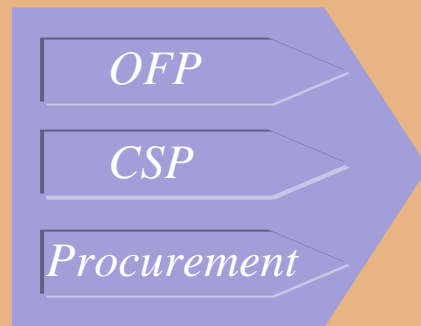
5.

6. Planning Process

7.

가

Process Redesign



... '97. 3Q

Software Selection



... '97. 4Q

System Implementation



System

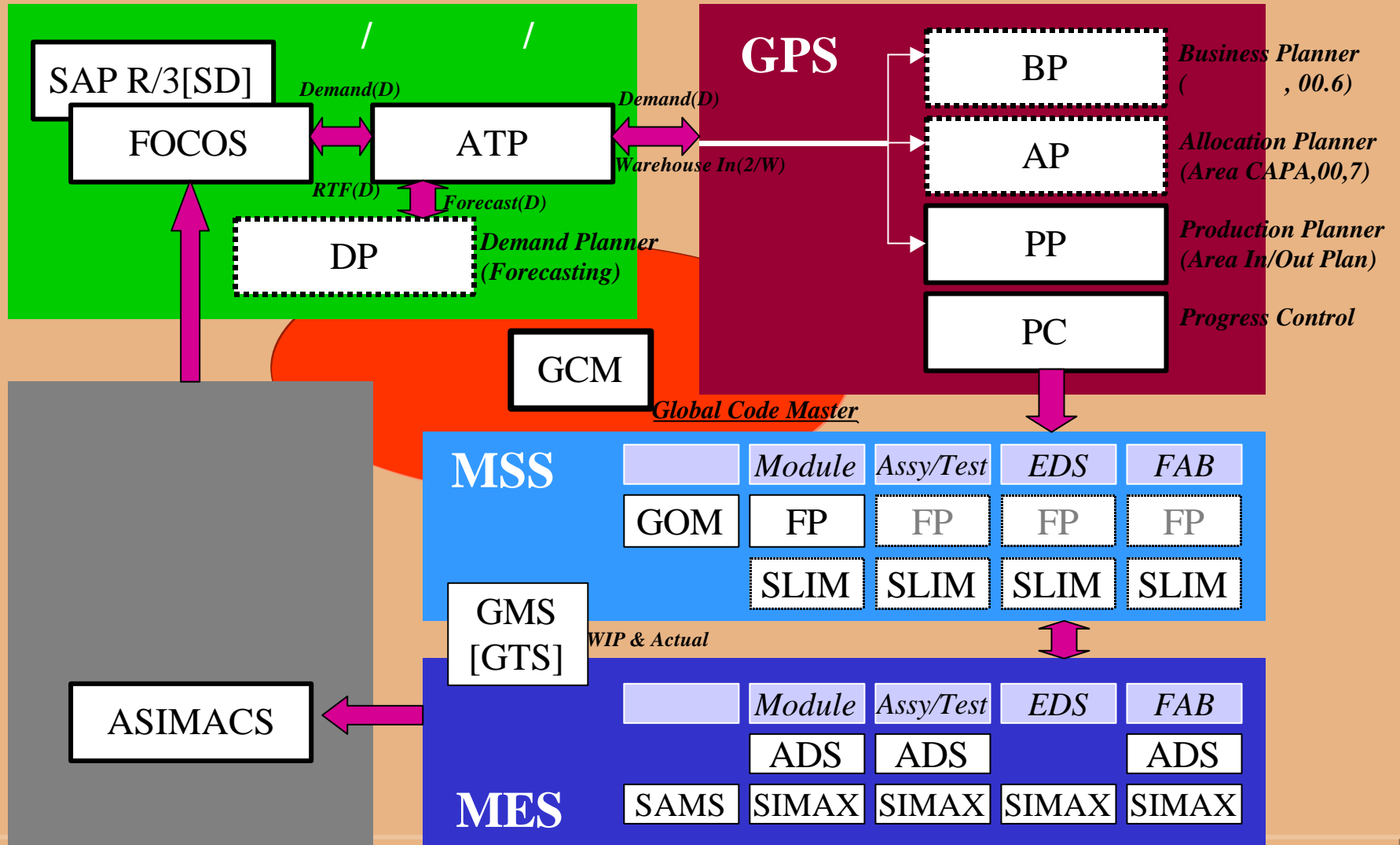
Semiconductor

[Key factor]

- Cycle Time
-
-
-
- Key Customer
- 가
-

- /
-
-
- Modeling
- OTD
- Demand Driven Planning
-

Semiconductor



GPS

- *Horizon : 13W*
- *Bucket : Engine Day, MSS I/F Half week*
- *: 週 2回(水; Rolling PLAN, 金; Incremental PLAN)*
- *Allocation, Alternate, MIN/MAX CAPA*
- *Bin/Down bin*
- *Time phased Cycle, Yield*
- *Frozen Planning*

ATP

- *Horizon : 13W, Bucket : Day, : Daily*
- *Demand*
- *Demand priority*
- *Flexibility [Demand change, New demand]*

GPS

- *Planning C/T : 3~7日 5Hr*
- *Product base Planning : F/E,B/E,Module*
- *Demand Driven Planning*
- *SCM*

ATP

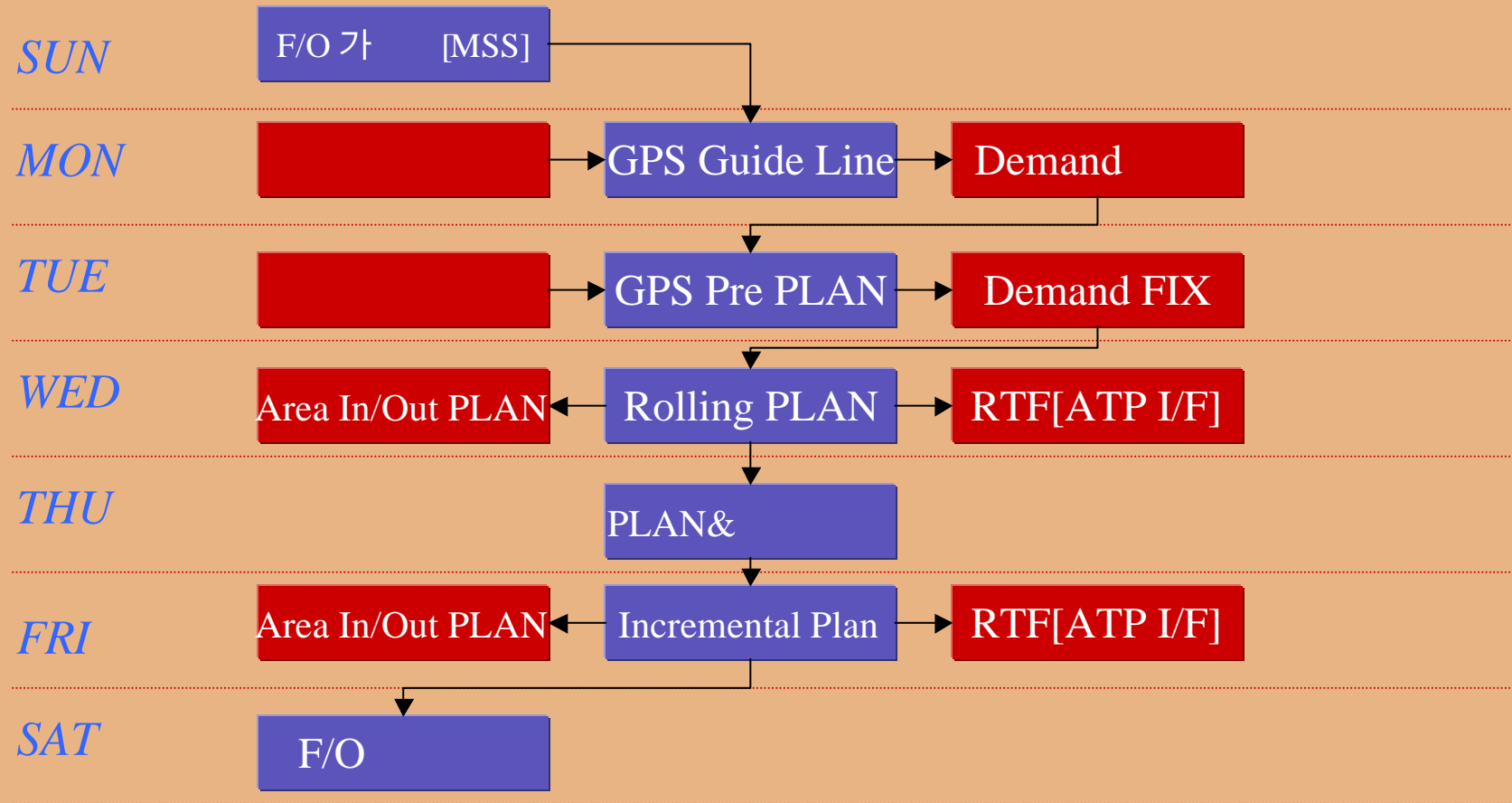
- *[RTF] : 2 Daily*
- *Flexibility [Demand change, New demand]*

FP

- *CAPA Scheduling[Module]*
- */ CAPA Allocation*

Planning Process[GPS]

Semiconductor



가

Semiconductor

Volume /OTD

가

- *VOLPAS*
- *LIPAS(Wafer/Chip/Test Out)*
- *OTD(On time delivery)*
- *RTF Keeping Rate*
-